

N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)		
40	0.006 at V _{GS} = 10 V	13	8 nC		
40	0.009 at V _{GS} = 4.5 V	11	OIIC		

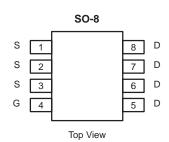
FEATURES

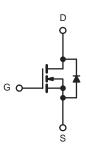
- Halogen-free According to IEC 61249-2-21
 TrenchFET[®] Power MOSFET
 100 % R_g and UIS Tested

COMPLIANT HALOGEN **FREE**

APPLICATIONS

- Notebook CPU Core
 - High-Side Switch





N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	40	V	
Gate-Source Voltage		V_{GS}	± 20	v	
	T _C = 25 °C		13		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C] [10		
Continuous Diain Current (1) = 150 °C)	T _A = 25 °C	l _D	12 ^{b, c}		
	T _A = 70 °C		9.6 ^{b, c}	^	
Pulsed Drain Current		I _{DM}	50	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	I.	4.5		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.2 ^{b, c}		
Single Pulse Avalanche Current	1 01 mll	I _{AS}	20		
alanche Energy L = 0.1 mH		E _{AS}	20	mJ	
	T _C = 25 °C		5		
Maximum Dawar Dissination	T _C = 70 °C	P _D	3.2	١٨/	
Maximum Power Dissipation	T _A = 25 °C	' b	2.5 ^{b, c}	mJ W	
	T _A = 70 °C	1 1	1.6 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R_{thJA}	38	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	20	25	C/ V V		

- a. Based on T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250A		34		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I _D = 250 μA		- 4.7			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.0		3.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaria Brain Comment	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current		V _{DS} = 40 V, V _{GS} = 0 V, T _J = 55 °C			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α	
	В	V _{GS} = 10 V, I _D = 10 A		0.006		1	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 7 A		0.009		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		30		S	
Dynamic ^b				1	ı		
Input Capacitance	C _{iss}			985		pF	
Output Capacitance	C _{oss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		205			
Reverse Transfer Capacitance	C _{rss}			76			
Tatal Oata Ohama		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		8			
Total Gate Charge	Q _g V _{DS} = 13 V, V _{GS} = 10 V, I _D = 10 A		8				
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		2.4		nC	
Gate-Drain Charge	Q _{gd}			2.3			
Gate Resistance	R _g	f = 1 MHz	0.3	1.3	2.6	Ω	
Turn-On Delay Time	t _{d(on)}			14	25		
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		12	24		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		19	35		
Fall Time	t _f			9	18	no	
Turn-On Delay Time	t _{d(on)}			8	16	- ns -	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		10	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		16	30		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			4.5	^	
Pulse Diode Forward Current ^a	I _{SM}				50	A	
Body Diode Voltage	V _{SD}	I _S = 3 A		0.76	1.1	V	
Body Diode Reverse Recovery Time	t _{rr}			14	28	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1 - 10 A dl/dt - 100 A/va T - 05 °C		5	10	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		8			
Reverse Recovery Rise Time		t _b		6	İ	ns	

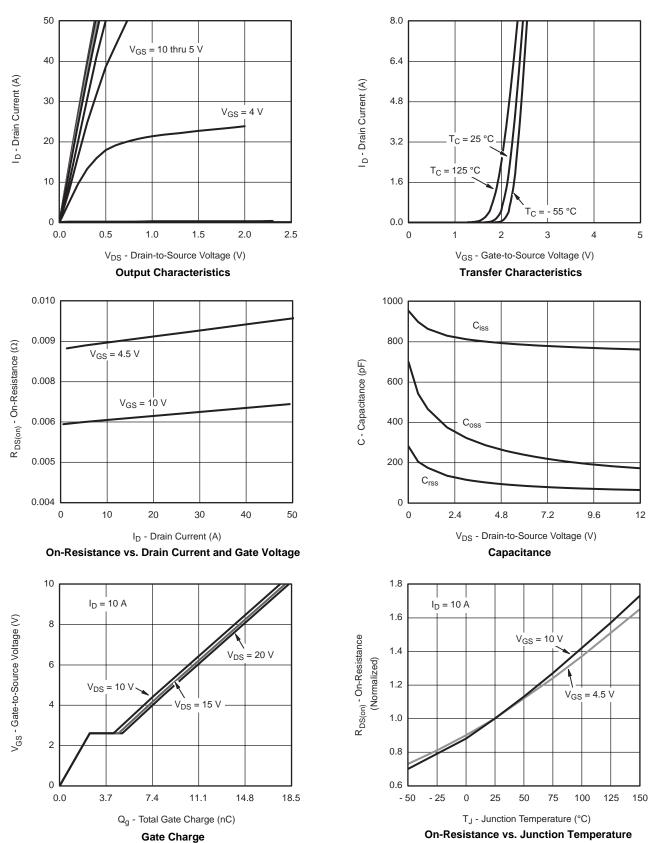
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

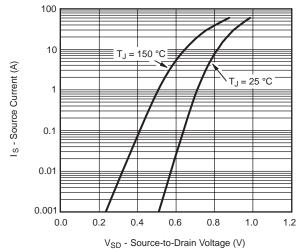


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

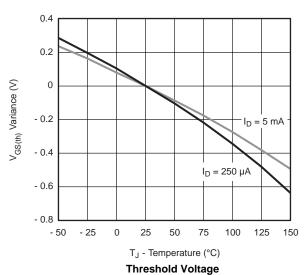


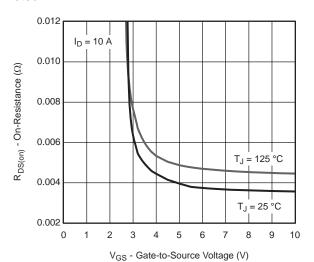


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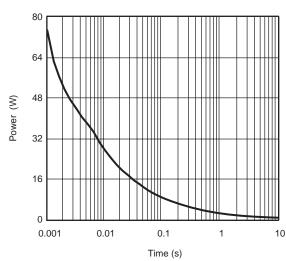


Source-Drain Diode Forward Voltage

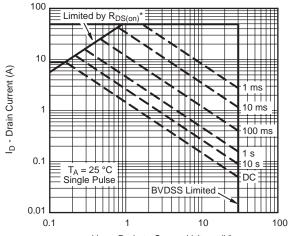




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



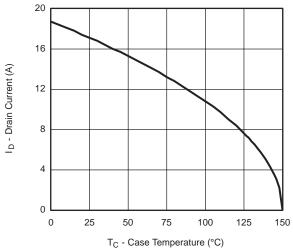
V_{DS} - Drain-to-Source Voltage (V)

Safe Operating Area, Junction-to-Ambient

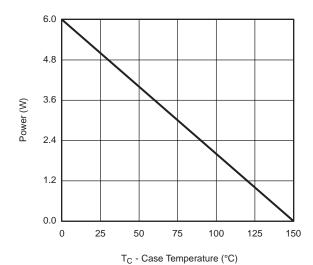
^{*} V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



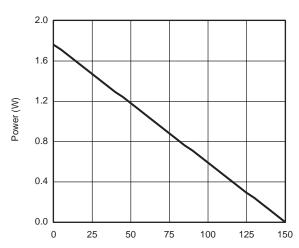
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





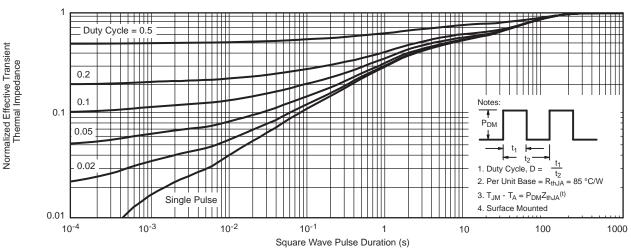


 T_A - Ambient Temperature (°C) Power Derating, Junction-to-Foot

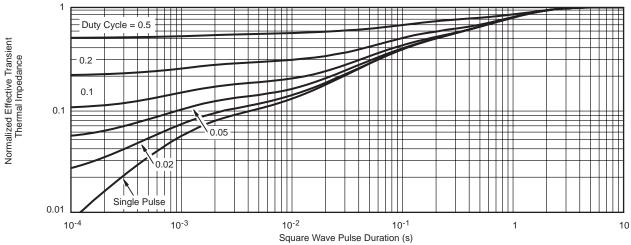
^{*} The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS 25 C, unless otherwise noted



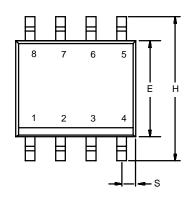
Normalized Thermal Transient Impedance, Junction-to-Ambient

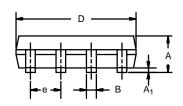


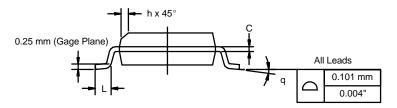
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







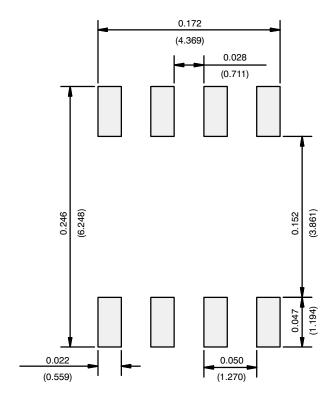
	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
FCN: C-06527-Rev I 11-Sen-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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